

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Hideobu FUKUTOME	09/18/2009
Mitsugu TAJIMA	09/24/2009
RECEIVING PARTY DATA	
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12567084
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Total Attachments: 1 source=091150_Assignment#page 1.tif	

OP \$40.00 12567084

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PATENT
REEL: 023646 FRAME: 0362

U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter, "ASSIGNOR") by
(Insert Name(s) & Address(es) of ASSIGNEE(S))

FUJITSU MICROELECTRONICS LIMITED

7-1, Nishi-Shinjuku 2-chome, Shinjuku-ku, Tokyo 163-0722 Japan

(hereinafter, "ASSIGNEE"), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled

SEMICONDUCTOR DEVICE AND METHOD OF MANUFACTURING THE SEMICONDUCTOR DEVICE

relating to International Patent Application PCT/JP _____ and/or for which application for Letters Patent of the United States was executed on even date herewith or, if not so executed, was:

(a) executed on _____

(Insert date of execution of application, if not concurrent)

(b) filed on _____

Serial No. _____

Assignee's attorney is hereby authorized to insert in (b) the specified data when known.

and to said application and all Letters Patent(s) of the United States granted on said application and any continuation, division, renewal, substitute, reissue or reexamination application based thereon, for the full term or terms for which the said Letters Patent(s) may be granted and including any extensions thereof (collectively, hereinafter, "said application(s) and Letters Patent(s)").

The ASSIGNOR agree(s), when requested by said ASSIGNEE and without charge to but at the expense of said ASSIGNEE, to do all acts which the ASSIGNEE may deem necessary, desirable or expedient, for securing, maintaining and enforcing protection for said invention, including in the preparation and prosecution of said application(s) and the issuance of said Letters Patent(s), in any interference, reissue, reexamination, or public use proceeding, and in any litigation or other legal proceeding which may arise or be declared in relation to same, such acts to include but not be limited to executing all papers, including separate assignments and declarations, taking all rightful oaths, providing sworn testimony, and obtaining and producing evidence.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

1) <u>福留 希暢</u> (Signature)	Hidenobu FUKUTOME (Type Name)	September 18, 2009 (Date)
2) _____ (Signature)	Hiroyuki OHTA (Type Name)	September 24, 2009 (Date)
3) <u>田島 貢</u> (Signature)	Mitsugu TAJIMA (Type Name)	September 24, 2009 (Date)
4) _____ (Signature)	_____ (Type Name)	_____ (Date)
5) _____ (Signature)	_____ (Type Name)	_____ (Date)

PATENT

RECORDED: 12/14/2009

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